

	Type	Hits	Search Text	DBs
77	BRS	7	(remov\$3 with etch\$3 with residue) same (precision adj surface)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
78	BRS	13	(precision adj surface) with (vias or trenches or cavities or channels)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
79	BRS	694	(remov\$3 with etch\$3 with residue) same substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
80	BRS	27110	substrate with (vias or trenches or cavities or channels)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
81	BRS	89	((remov\$3 with etch\$3 with residue) same substrate) and (substrate with (vias or trenches or cavities or channels))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
82	BRS	6	substrate with (vias and trenches and cavities and channels)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
83	BRS	0	((remov\$3 with etch\$3 with residue) same substrate) and (substrate with (vias and trenches and cavities and channels))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
84	BRS	413	(remov\$3 with etch\$3 with residue) with substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
85	BRS	54	((remov\$3 with etch\$3 with residue) with substrate) and (substrate with (vias or trenches or cavities or channels))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB

	Time Stamp	Comments	Error Definition	Errors
77	2003/02/03 14:37			0
78	2003/02/03 14:37			0
79	2003/02/03 14:43			0
80	2003/02/03 14:42			0
81	2003/02/03 14:44			0
82	2003/02/03 14:42			0
83	2003/02/03 14:43			0
84	2003/02/03 14:44			0
85	2003/02/03 14:44			0